W-38/21/2022-IPHW
Government of India
Ministry of Electronics and Information Technology
(IPHW Division)

New Delhi, the 21st September, 2026

Subject: Addendum to the Guidelines of 'Modified Programme for setting up of Compound Semiconductors / Silicon Photonics / Sensors Fab/ Discrete Semiconductors Fab and Semiconductor Assembly, Testing, Marking and Packaging (ATMP)/ Outsourced Semiconductor Assembly and Test (OSAT) facilities in India'

The following paragraph 7.7 is added in the Guidelines and its amendments of the Modified Programme for setting up of Compound Semiconductors / Silicon Photonics / Sensors Fab/ Discrete Semiconductors Fab and Semiconductor Assembly, Testing, Marking and Packaging (ATMP)/ Outsourced Semiconductor Assembly and Test (OSAT) facilities in India':

"7.7 Extension of Tenure of the Project: The tenure of the project including the period of actual fiscal support outflow to the approved units may be extended with the approval of the Minister of Electronics and Information Technology."

(Sushil Pal)
Joint Secretary to the Government of India